Clean Room Handbook
Rev. 2.1.4

Yale SEAS Cleanroom
A Yale University CORE Laboratory
Ammended requirements for qualification
Undergraduate requirements
External customers
Ammended policy 5.1 User Fees and Costs
Responsibility to Provost’s Office
Ammended policy 5.6.1 Hours of operation
8AM- 5PM Monday thru Friday
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http://www.eng.yale.edu/cleanroom/
The publication of this cleanroom user’s handbook is motivated by the desire and need to inform and guide the new or returning cleanroom user in the rules, features, and guidelines for the successful conduct of research in the facility. This will be a live document; as our cleanroom organization matures, and as we make the inevitable changes and additions to the facility, the contents of this guide will change with it.
Introduction

Brief history of the Becton CR

The “original” Becton Cleanroom was built in 1988 for $1.2M. Its pertinent design specifications:

2,600 square feet
One bay Class 100 with the remainder Class 1,000
Temperature 68 ±4° F
Humidity 40 ±5%
Staff: 1 Technician/manager
Entire budget paid by user fees
Building facilities maintained by physical plant

The original faculty founders were Dick Barker, T.P. Ma, Dan Prober, and Bob Wheeler

Over the course of the last 20 or so years, this facility has gone from supporting five or six faculty members in 3 departments to over 30 faculty in 8 departments and more than 130 cleanroom users.

Estimated research relying on cleanroom usage: $3-4 M/yr total (2004/05), with quantum computing alone accounting for approx. $2 M/yr (2004/05), with 100% reliance on the cleanroom.

In early 2005, Dean Fleury formed an Executive Committee composed of Profs. T.P. Ma, J. Han, and R. Schoelkopf. The committee issued a report (6/05) finding significant problems with Becton cleanroom. These problems included:

1) Environmental systems failing
   - Air handler past useful life, accumulates water
   - Cleanroom environment no longer meets specs
   - Dehumidifier (DX coil) removed sometime in 2003
Pneumatic controls antiquated, no logging of data

2) Potentially serious safety issues
   - Toxic/flammable gas storage not up to code
   - Electrical code violations
   - Wet benches: too few, flammable, ventilation inadequate

3) Tool set out of date, maintenance problematic
   - No plasma etching, mask making …

4) Understaffed, no direct university support!

The University responded in several ways:

1) Two new CR staff positions were authorized and funded by the Provost’s office

2) The purchase of approx. $ 1.7M in new cleanroom tools was authorized and funded by the Provost’s office

3) A comprehensive cleanroom redesign was begun in 2005. Midwest Cleanroom Associates (MCA) were selected to serve as consultants and commissioning agents on the subsequent renovation project

4) The major renovation project was begun 3/07 and completed by 09/07

5) Certification and commissioning completed by 10/07
Cleanroom Specifications

2007 Yale FOE CR 2.0 Design Specifications

Temperature: \(68 \pm 2^\circ F\) sensed at 10 points, with remote telemetry and logging
Relative Humidity: \(45 \pm 5\%\) sensed at 10 points, with remote telemetry and logging

(source: Basis of Design, Midwest Cleanroom Associates, April 13, 2006)

Total make up air flow, scfm 17600
Total exhaust flow, scfm 16000

Particle counts
ISO 5 = “Class 100” = \(<100 \text{ per ft}^3\)
ISO 6 = “Class 1000” = \(<1000 \text{ per ft}^3\)
2 fixed particle counters with remote telemetry and trending

DI water
RO quality dissolved solids reduction by \(> 96\%\)
Bacteria reduction by \(> 99\%\)
Particulate removal down to 5 μm in size

RO capacity, gallons/day \(> 4400\)
RO storage capacity, gal 500
DI Resistivity, Ω-cm \(18 \times 10^6\), with remote telemetry and logging

DI loop flow, gpm 25, with duplex alternating distribution pumps

DI loop delivery pressure 90 psi at pump discharge
Final filter 0.2 μm, stainless steel housing
Resistivity Monitors supply and return, temperature compensated

DI piping material PVDF

Process chilled water
Max. flow, gpm 60
Max. heat load, BTU/h 180000
Supply Temperature \(< 60^\circ F\), or just above dew point; adjustable, telemetered, and trended.

Δ Pressure adjustable, 10 psi minimum
<table>
<thead>
<tr>
<th>Description</th>
<th>Details</th>
</tr>
</thead>
<tbody>
<tr>
<td>Compressed dry air</td>
<td>80-100 psig, from building supply, dual lead-lag source</td>
</tr>
<tr>
<td>House nitrogen</td>
<td>approx 60 psig from liquid boiloff</td>
</tr>
<tr>
<td>House vacuum</td>
<td>min. 21” Hg, dual lead-lag pumps</td>
</tr>
</tbody>
</table>
Organization Chart

Deputy Provost

Dean of Engineering

Clean Room Director

Advisory Committee

Clean Room Staff

Clean Room Users

Academic, Scientific Issues and Planning
1.0 **Requirements for qualification**

Users needing to use the cleanroom that have never been previously qualified for the Yale cleanroom.

Graduate students, researchers, and faculty

1. Obtain the approval of the principal investigator / faculty member who has agreed to be financially responsible for the user’s cleanroom usage.

2. Complete the application form, available at: (URL location)

3. Complete the following Yale online training courses:
   - OEHS online chemical safety training, located at [http://info.med.yale.edu/chemsafe](http://info.med.yale.edu/chemsafe)
   - OEHS online hazardous chemical waste training, at [http://www.yale.edu/oehs/onlinetraining/hazwaste/chemicalwaste.htm](http://www.yale.edu/oehs/onlinetraining/hazwaste/chemicalwaste.htm)
   - Yale Fire Marshal’s online Fire Extinguisher training, at [https://bmsweb.med.yale.edu/tms/tms_enrollments.offerings?p_crs_id=2074#](https://bmsweb.med.yale.edu/tms/tms_enrollments.offerings?p_crs_id=2074#)

4. Meet with the CR manager, explain your reasons for using cleanroom and discuss your requirements.

5. Attend an in-house orientation provided by cleanroom staff, to cover the following topics:
   - Mechanics of cleanroom entry/exit: gowning, card access
   - Characteristics of CR areas, air pressure, particle count
   - Process bays, service bays, identification and protocols

6. Classroom and lab training for safety and chemical handling.
   - PPE requirements
   - Emergency response protocols
   - Chemical handling
   - Proper use of each of the chemical process benches and hotplates
7. **Introduction to Coral**
   - Using remote Coral
   - How to schedule equipment
   - How to know status of equipment

8. Pass a written exam. The exam will cover items from (5) through (7) above. The exam will be administered after the completion of the previous items. The exam will be graded by the cleanroom staff. Those not passing the exam will be allowed sufficient time to review the appropriate materials (this handbook, online course work, etc) before retaking the exam.

9. Attend and participate in a cleanroom walkthrough by a cleanroom staff member. The items to be demonstrated will include (at a minimum):
   - Prox card entry and exit protocol
   - Proper gowning / degowning
   - Location of safety equipment, PPE, and supplies
   - Location of spill kits and first aid
   - Location of supplies and chemicals
   - Location of ringdown phones and alarms
   - Proper hazardous waste labeling
   - Coral scheduling and equipment enabling

10. Additional individual one on one training is required to qualify for approval to use process tools and systems, please see a staff member to schedule training.

11. Anyone who has previously been qualified for access to the cleanroom and has less than 30 hours of active cleanroom time per 12 month period, will need the approval of the cleanroom manager, and review process equipment and procedures with a staff member, in order to maintain active status.
Undergraduate students

All undergraduate student researchers desiring to have access to the cleanroom must be at the SENIOR undergraduate level as verified from their transcript and at least 20 years of age.

1. Students must interview with the cleanroom management to establish their maturity, skills and capability in regard to cleanroom operations. Any reservations will be brought to the attention of the sponsoring faculty member.

2. Once approved by the cleanroom management, all students must take all safety training courses as required by cleanroom management and must pass with a grade of 70% minimum.

3. After senior level students pass the courses, faculty responsible for the senior undergraduate student MUST arrange for them to be accompanied by an EXPERIENCED graduate student or postdoc (also under the associated faculty member’s supervision) during EACH of their entire sessions in the cleanroom. Cleanroom staff will not be responsible for the direct supervision of these students. Ultimately, the sponsoring faculty member is absolutely responsible for all of their student researchers. Of course, faculty members are also welcome to come into the cleanroom and monitor their students directly as well.

4. Access for these senior level undergraduate students will be during weekdays only, Mon-Fri between 8 AM and 5 PM.

5. An email from the student’s sponsor verifying that the student meets these conditions should be made to the Cleanroom Director and Associate Director.
External customers and external affiliated researchers

Any non Yale researchers interested in using the cleanroom, must contact the cleanroom director, who will determine if there is an appropriate association to allow the use of university laboratories.
2.0 Cleanroom Training
A Basic Introduction to Clean Rooms

By Roger McFadden
Technical Director, Coastwide Laboratories

A cleanroom is a controlled environment where products are manufactured. It is a room in which the concentration of airborne particles is controlled to specified limits. Eliminating sub-micron airborne contamination is really a process of control. These contaminants are generated by people, process, facilities and equipment. They must be continually removed from the air. The level to which these particles need to be removed depends upon the standards required. The most frequently used standard is the Federal Standard 209E. The 209E is a document that establishes standard classes of air cleanliness for airborne particulate levels in cleanrooms and clean zones. Strict rules and procedures are followed to prevent contamination of the product.

The only way to control contamination is to control the total environment. Air flow rates and direction, pressurization, temperature, humidity and specialized filtration all need to be tightly controlled. And the sources of these particles need to controlled or eliminated whenever possible. There is more to a clean room than air filters. Cleanrooms are planned and manufactured using strict protocol and methods. They are frequently found in electronics, pharmaceutical, biopharmaceutical, medical device industries and other critical manufacturing environments.

It only takes a quick monitor of the air in a cleanroom compared to a typical office building to see the difference. Typical office building air contains from 500,000 to 1,000,000 particles (0.5 microns or larger) per cubic foot of air. A Class 100 cleanroom is designed to never allow more...
than 100 particles (0.5 microns or larger) per cubic foot of air. Class 1000 and Class 10,000 cleanrooms are designed to limit particles to 1000 and 10,000 respectively.

A human hair is about 75-100 microns in diameter. A particle 200 times smaller (0.5 micron) than the human hair can cause major disaster in a cleanroom. Contamination can lead to expensive downtime and increased production costs. In fact, the billion dollar NASA Hubble Space Telescope was damaged and did not perform as designed because of a particle smaller than 0.5 microns.

Once a cleanroom is built it must be maintained and cleaned to the same high standards. This handbook has been prepared to give professional cleaning staff information about how to clean the cleanroom.

What is Contamination?

Contamination is a process or act that causes materials or surfaces to be soiled with contaminating substances. There are two broad categories of surface contaminants: film type and particulates. These contaminants can produce a “killer defect” in a miniature circuit. Film contaminants of only 10 nm (nanometers) can drastically reduce coating adhesion on a wafer or chip. It is widely accepted that particles of 0.5 microns or larger are the target. However, some industries are now targeting smaller particles.

A partial list of contaminants is found below. Any of these can be the source for killing a circuit. Preventing these contaminants from entering the cleanroom environment is the objective. It requires a commitment by everyone entering the cleanroom to make it happen. Professional cleaning personnel need to be aware of the importance of controlling contaminants. Strict procedures should be followed whenever entering or cleaning a cleanroom. Compromise is not acceptable when cleaning in a cleanroom.

Sources of Contamination

This is a partial list of some of the commonly known contaminants that can cause problems in some cleanroom environments. It has been found that many of these contaminants are generated from five basic sources. The facilities, people, tools, fluids and the product being manufactured can all contribute to contamination. Review this list to gain a better understanding of where contamination originates.
1. **Facilities**

- Walls, floors and ceilings
- Paint and coatings
- Construction material (sheet rock, saw dust etc.)
- Air conditioning debris
- Room air and vapors
- Spills and leaks

2. **People**

- Skin flakes and oil
- Cosmetics and perfume
- Spittle
- Clothing debris (lint, fibers etc.)
- Hair

3. **Tool Generated**

- Friction and wear particles
- Lubricants and emissions
- Vibrations
- Brooms, mops and dusters

4. **Fluids**

- Particulates floating in air
- Bacteria, organics and moisture
- Floor finishes or coatings
- Cleaning chemicals
- Plasticizers (outgasses)
- Deionized water

5. **Product generated**

- Silicon chips
- Quartz flakes
- Cleanroom debris
- Aluminum particles
Key Elements of Contamination Control

We will look at several areas of concern to get a better idea of the overall picture of contamination control. These are the things that need to be considered when providing an effective contamination control program.

**HEPA (High Efficiency Particulate Air Filter)** - These filters are extremely important for maintaining contamination control. They filter particles as small as 0.3 microns with a 99.97% minimum particle-collective efficiency.

**CLEANROOM ARCHITECTURE** - Cleanrooms are designed to achieve and maintain an airflow in which essentially the entire body of air within a confined area moves with uniform velocity along parallel flow lines. This air flow is called laminar flow. The more restriction of air flow the more turbulence. Turbulence can cause particle movement.

**FILTRATION** - In addition to the HEPA filters commonly used in cleanrooms, there are a number of other filtration mechanisms used to remove particles from gases and liquids. These filters are essential for providing effective contamination control.

**CLEANING** - Cleaning is an essential element of contamination control. Decisions need to made about the details of cleanroom maintenance and cleaning. Applications and procedures need to be written and agreed upon by cleanroom management and contractors (if used). There are many problems associated with cleaning. Managers need to answer the following questions before proceeding with any cleanroom cleaning program:

1. What is clean?
2. How is clean measured?
3. What cleaning materials can be used in the cleanroom?
4. When can the cleanroom be cleaned?
5. How frequent does it need to be cleaned?

**CLEANROOM GARMENTS** - The requirements for cleanroom garments will vary from location to location. It is important to know the local garment requirements of the cleanroom management. Gloves, face masks and head covers are standard in nearly every cleanroom environment. Smocks are being used more and more. Jump suits are required in very clean environments.
HUMANS IN CLEANROOMS - There are both physical and psychological concerns when humans are present in cleanrooms. Physical behavior like fast motion and horseplay can increase contamination. Psychological concerns like room temperature, humidity, claustrophobia, odors and workplace attitude are important. Below are several ways people produce contamination:

1. **Body Regenerative Processes** -- Skin flakes, oils, perspiration and hair.
2. **Behavior** -- Rate of movement, sneezing and coughing.
3. **Attitude** -- Work habits and communication between workers.

People are a major source of contamination in the cleanroom. Look at the people activities listed below. Notice the number of particles produced per minute during these activities.

<table>
<thead>
<tr>
<th>PEOPLE ACTIVITY</th>
<th>PARTICLES/MINUTE (0.3 microns and larger)</th>
</tr>
</thead>
<tbody>
<tr>
<td>Motionless (Standing or Seated)</td>
<td>100,000</td>
</tr>
<tr>
<td>Walking about 2 mph</td>
<td>5,000,000</td>
</tr>
<tr>
<td>Walking about 3.5 mph</td>
<td>7,000,000</td>
</tr>
<tr>
<td>Walking about 5 mph</td>
<td>10,000,000</td>
</tr>
<tr>
<td>Horseplay</td>
<td>100,000,000</td>
</tr>
</tbody>
</table>

COMMODITIES - Care is taken when selecting and using commodity items in cleanrooms. Wipers, cleanroom paper and pens and other supplies that service the cleanroom should be carefully screened and selected. Review of the local cleanroom requirements for approving and taking these items into the cleanroom are essential. In fact, many cleanroom managers will have approval lists of these types of items.

COSMETICS - Many cosmetics contain sodium, magnesium, silicon, calcium, potassium or iron. These chemicals can create damaging particles. Cleanroom managers may ban or restrict cosmetics in the cleanroom. This is usually dependent upon the threat to the product being made in the cleanroom. A recent mirror on a space telescope was fogged up from the cologne that was present in the cleanroom.
MEASUREMENT AND INSTRUMENTATION - Some important measurements related to contamination control are particle count, air flow & velocity, humidity, temperature and surface cleanliness. Cleanroom managers usually have specific standards and/or instruments to measure these factors.

ELECTROSTATIC DISCHARGE (ESD) - When two surfaces rub together an electrical charge can be created. Moving air creates a charge. People touching surfaces or walking across the floor can create a triboelectric charge. Special care is taken to use ESD protective materials to prevent damage from ESD. Cleaning managers should work with their personnel to understand where these conditions may be present and how to prevent them.

General Cleanroom Regulations

Below is a list of general regulations recommended as a minimum for the successful operation of a cleanroom. All professional cleaning personnel should be aware and follow these regulations at all times.

1. All personal items such as keys, watches, rings, matches, lighters and cigarettes should be stored in the personal locker outside the gowning room.

2. Valuable personal Items such as wallets may be permitted in the cleanroom provided they are NEVER removed from beneath the cleanroom garments.

3. NO eating, smoking or gum chewing allowed inside the cleanroom.

4. Only garments approved for the cleanroom should be worn when entering.

5. NO cosmetics shall be worn in the cleanrooms. This includes: rouge, lipstick, eye shadow, eyebrow pencil, mascara, eye liner, false eye lashes, fingernail polish, hair spray, mousse, or the heavy use of aerosols, after shaves and perfumes.

6. Only approved cleanroom paper shall be allowed in the cleanroom.

7. Approved ball point pens shall be the only writing tool used.
8. Use of paper or fabric towels is prohibited. Use of hand dryers equipped with HEPA filters is suggested.

9. Gloves or finger cots should not be allowed to touch any item or surface that has not been thoroughly cleaned.

10. Only approved gloves, finger cots (powder-free), pliers, tweezers should be used to handle product. Finger prints can be a major source of contamination on some products.

11. Solvent contact with the bare skin should be avoided. They can remove skin oils and increase skin flaking.

12. Approved skin lotions or lanolin based soaps are sometimes allowed. These can reduce skin flaking.

13. All tools, containers and fixtures used in the cleaning process should be cleaned to the same degree as the cleanroom surfaces. All of these items are a source of contamination.

14. NO tool should be allowed to rest on the surface of a bench or table. It should be place on a cleanroom wiper.

15. Only cleanroom approved wipers are allowed to be used. The wipers must be approved for the Class of cleanroom being cleaned.

16. ALL equipment, materials and containers introduced into a sterile facility must be subjected to stringent sterilization prior to entrance.

17. NO ONE who is physically ill, especially with respiratory or stomach disorders, may enter a sterile room. This is a good practice in any cleanroom environment.

**Personal Actions Prohibited in Cleanrooms**

1. Fast motions such as running, walking fast or horseplay.
2. Sitting or leaning on equipment or work surfaces.
3. Writing on equipment or garments.
4. Removal of items from beneath the cleanroom garments.
5. Wearing the cleanroom garment outside the cleanroom.
6. Wearing torn or soiled garments.
2.2 Orientation Walkthrough

Minimal List of Items to be Covered during an initial Cleanroom Walkthrough

1. Cleanroom entry and exit protocols
2. ISO5/class 100 and ISO6/class 1000 areas
3. service bays, process bays
4. differential pressures between areas
5. particle counters
6. fire extinguishers
7. eyewashes and safety showers
8. ringdown/emergency phones
9. emergency gas off buttons
10. hazardous gas alarm lights, detectors, and status panel
11. wet process benches – location, purpose
12. doors – entry, emergency exit, service bay, sliding
2.3 SEAS CR Personal Contamination Control

1. Entry

Before entering the cleanroom, ensure that you have: eye protection [see section 6.0, “PPE”], and that you are suitably attired (long pants/trousers, full-coverage shoes, no sandals/flip-flops, no high heels). Be sure to leave your MP3/iPod players in your office as well – they are inappropriate for work in the cleanroom, where paying attention to your environment is important for your safety and the safety of others.

Enter the cleanroom using your Yale ID Proxcard. The door will swing open for you, once your card has authenticated you. If you are entering while other people are entering or leaving, be sure to prox your card (you’ll hear the card reader beep) even if the door is already open, as this “logs” you in to the cleanroom.

The first thing you’ll do is walk over a tacky mat. If the mat is getting dirty, don’t hesitate to pull up the next sheet.

If you are bringing in an item to place in the passthrough: You will find a supply of lab wipes, and a spray bottle of IPA on the rack near the passthrough. Use the spray and the wipes to clean the item before placing it in the passthrough. At this point, think about your cell phone – if you are going to need it in the cleanroom, wipe it down and place it in the passthrough. Once you are gowned up, you won’t be able to pull it out of your pocket if it rings.

Notice the oval-shaped knob next to the passthrough door. This knob operates the door interlock. Turn it counterclockwise to allow “your” door to open. When you close the door, turn the knob clockwise – this now allows the door on the cleanroom side to operate. You will find a similar knob on the cleanroom side, and it has the same function.

Next, before donning the blue shoe covers, make use of the shoe cleaner, located near the entry door. Use it to remove the dirt on your shoes, and then pull the shoe covers over your shoes.

Now put on a pair of vinyl gloves. You will wear these while gowning. Also put on the bouffant hair cover, tucking your hair underneath if
appropriate. If you have a beard or moustache (more than two days growth for most men), also put on a beard cover.

If you do not already have a gown and a hood hanging up in the gowning room, choose one of each now, of the appropriate size, from the rack. Sizes are labeled, and range from small on the left to 3XL on the right (small to XL for hoods).

Now you’re ready to step through the door to the gowning room, and onto the next tacky mat. If it’s getting dirty, please pull up the next sheet. (Clearly, if the shoe cleaner and the shoe covers are doing their job, it will take a while for this mat to get dirty!)

We gown up in “top-down” fashion. First put on the hood, ensuring the snaps face outward. Tuck in your hair. Fasten the hood closure, and adjust the fit snaps as needed. A full-length mirror is available in the gowning room to help you make sure you have the hood on right, all your hair is tucked in properly, etc.

Next, step into the coverall, while preventing the coverall from contacting the floor as much as possible. This takes some practice to do well. Fasten the coverall with the front zipper, ensuring the hood tails are completely tucked in to the neck of the coverall. Use the full-length mirror to verify that you are “tucked in” completely.

Finally, put on the boots over your blue shoe covers. Use the adjustable strap to secure the lower part of the boot against your foot and shoe. Tuck the coverall into the top part of the boot, fasten the top of the boot to the bottom of the coverall with the snaps provided, and secure the top strap snugly with its snap.

Select the appropriate glove for your intended activity in the cleanroom. The blue nitrile gloves are appropriate for most chemical work. The vinyl gloves, for some, are more comfortable and allow a bit more tactile feedback, but are not appropriate for any chemical work.

Finally, recheck your gowning in the full-length mirror. If you notice anything amiss, fix it now before stepping onto the last tacky mat and into the cleanroom.
2. Exit

The degowning procedure is essentially the reverse of the gowning procedure. While still gloved, remove your garments in “bottom-up” fashion – remove the boots, then the coverall (again being careful to not let it contact the floor). Hang up the coverall on your hangar. You can now snap your boots to the bottoms of the coverall legs to keep all your garments together. Finally, remove the hood, and snap it to the coverall as well.

Next, step out into the entryway and retrieve your possessions from the passthrough (remembering to unlock/lock the door interlock as before). Finally, remove and dispose of the blue shoe covers, your vinyl gloves, and your hair and beard cover.

To operate the hallway door, prox your ID card on the pad adjacent to the door. The door will operate automatically. This also “logs” you out of the cleanroom.
The following document provides detailed instructions for every phase of chemical handling in the Yale Cleanroom from storage through disposal. These procedures are designed to ensure the safety of everyone who uses the facility as well as to comply with federal and state regulations. Everyone who is admitted to the facility should be familiar with these procedures. Reading and knowing these procedures in no way qualifies you to enter or do any work in the cleanroom, although it is a pre-requisite. Further, some equipment discussed in this document, namely the CMOS hood, has additional procedural requirements that should not supersede these procedures but must be followed in addition.

Fresh Chemicals Storage and Transporting
Bottles of fresh chemicals are to be stored in one of the two chemical pass-through cabinets or in the small cabinets under the proper benches. The chemical bottles should be wiped down prior to being placed in the pass-through from the outside hallway to minimize particulates. Bottles of fresh acid or caustic chemicals other than developer should be transported from the cabinet to the hoods using a rubber bucket and one heavy nitrile glove. This allows the user to have one free hand to open the door and one protected hand to carry the bucket. Bottles should be returned to the proper storage location immediately after use. Rubber buckets should be left near the pass through cabinets.

Acids:

Fresh acids should be stored in the trays on the 2nd and 3rd shelves of the corrosives pass-through. There is also room for ~8 bottles of acid under the Acid Hood. To avoid unnecessary searching for a particular acid, commonly used acids will have a specific location in one of these cabinets and the cabinets will be labeled with this information. These chemicals and their locations are designated on the Chemical Storage Chart. Other bottles must be stored in the corrosives cabinet. Over time, we may find that the frequently used chemical list changes and we will adjust the Chemical Storage Chart accordingly.

Bases/Caustics:

Fresh bases and caustic-based chemicals should be stored in the trays on the top shelf of the corrosives pass-through. This includes developers as well as strong bases. There is room for ~8 bottles of caustics under the Base/ Caustics Hood. Develops
will be stored on the left side and strong bases will be stored under the right side. As with the acids, each chemical will have a specific location in one of these cabinets and the cabinets will be labeled with this information. These chemicals and their locations are designated on the Chemical Storage Chart. Developers will also be stored under the right hand cabinet of the Solvent Hood.

Hydrogen Peroxide:

Hydrogen peroxide should be stored with the bases in the corrosives pass through. It may also be stored in the right hand cabinet of the Base Hood.

Solvents:

Fresh solvents should be stored on the top two shelves of the flammables cabinet. They will also be stored in the left hand cabinet of Spinner Hood #1 and the left side of the Solvent Hood. Some SU-8 related solvents such as SU-8 developer and EBR PG will be stored under the left side of the MEMS Hood. See the Chemical Storage Chart for details.

Photoresists, E-beam resists, Primers:

Fresh bottles of photoresist should be stored in the explosion-proof refrigerator in the lithography bay to preserve their lifetime. They may also be stored temporarily on the 2nd shelf of the flammables cabinet. Small bottles in-use may be stored on the bench top of Spinner Hood #1 and Spinner Hood #2. E-beam resists should be stored on the second shelf of the flammables pass-through. Photoresist primer should be stored on the second shelf of the flammables-pass through. Epoxy based resists such as SU-8 as well as fresh bottles of lift-off resists should be stored under the right side of the MEMS Hood.

CMOS bench:

This bench is listed separately because it is the only place where acids, bases, and solvents are to be used in the same hood. There is room for a few commonly used chemicals in the cabinets under the hood. Fresh and waste acids will go in the left hand cabinet. Fresh and waste solvents will go in the right hand cabinet. See the Chemical Storage Chart for details. The
two middle cabinets are used to store the carboys for the two process tanks.

**Personal Protective Equipment**

Various tasks in the cleanroom carry various requirements for using personal protective equipment. The purpose of these rules is not to hinder your work but to keep you and those around you safe. Proper PPE will greatly reduce the risk of an injury should you or someone around you cause a chemical accident. Each chemical bench has specific PPE requirements for anyone working there. These requirements also apply to someone observing work at that bench.

**General Cleanroom areas:**

Users are required to wear safety glasses at all times when they are in the cleanroom. Nitrile or vinyl gloves are also mandatory.

**Transporting Chemicals:**

Every effort has been made to minimize the number of times a user needs to carry a bottle from the cabinets to the benches or vice-versa. Even so, we have a limited amount of storage space under the benches and thus you will probably have to do this sometimes. At a minimum you must be wearing regular nitrile gloves and safety glasses before retrieving chemicals from the cabinets. This is sufficient for solvents and developer. These may be safely transported without the rubber buckets.

Acids and caustics (besides developer) require slightly more caution.

- Users should get a single green nitrile glove and a rubber bucket.
- Wearing the green glove, place the chemical into the bucket and carry it using the gloved hand.
- The ungloved hand should be used for opening the door to avoid contaminating the button.

This procedure should be repeated when returning chemicals to the cabinet. This method should also be used when transporting chemicals to the MOS hood. It will minimize the likelihood of dropping a bottle between the cabinet and the hood.
Acid hood:

All users working or observing at the acid hood are required to wear safety glasses, a face shield, a chemical apron, and the heavy green nitrile gloves. Even if you are using what you believe are “less-dangerous” chemicals you must still use the full PPE because of the possibility that someone else has left “more dangerous” chemicals in the hood and the likelihood that the surfaces of the bench are contaminated with these chemicals.

The apron should be put on first with the side labeled “Chemical side” facing the bench, followed by the face shield, and finally the green gloves to avoid touching the apron and face shield with contaminated gloves. Green gloves should be removed before removing shield or apron. Rinse and dry any contaminated gloves before removing them.

Base Hood:

All users working or observing at the base hood are required to wear safety glasses, a face shield, a chemical apron, and heavy green nitrile gloves. Even if you are using what you believe are “less-dangerous” chemicals you must still use the full PPE because of the possibility that someone else has left “more dangerous” chemicals in the hood and the likelihood that the surfaces of the bench are contaminated with these chemicals.

The apron should be put on first with the side labeled “Chemical side” facing the bench, followed by the face shield, and finally the green gloves to avoid touching the apron and face shield with contaminated gloves. Green gloves should be removed before removing shield or apron. Rinse and dry any contaminated gloves before removing them.

MOS Hood

The MOS hood is unique in that it is used for acid- and caustic-based chemistry as well as solvents and thus it presents more hazards than any of the other benches.

All users working or observing at the MOS hood are required to wear safety glasses, a face shield, a chemical apron, and heavy green nitrile gloves. Even if you are using “less-dangerous” chemicals you must still use the full PPE because of the possibility that someone else has left “more dangerous”
chemicals in the hood and the likelihood that the surfaces of the bench are contaminated with these chemicals.

The apron should be put on first with the side labeled “Chemical side” facing the bench, followed by the face shield, and finally the green gloves to avoid touching the apron and face shield with contaminated gloves. Green gloves should be removed before removing shield or apron. Rinse and dry any contaminated gloves before removing them.

**Spinner Hoods #1 and #2:**

Users at the spinner benches must wear at least safety glasses and regular nitrile gloves.

**Solvent Hood:**

Users at the spinner benches must wear at least safety glasses and regular nitrile gloves. Heavy nitrile gloves and face shield are strongly recommended when using heated solvents.
Chemical pouring and use procedures

Chemicals in-use

All chemicals in the benches must be properly labeled and covered whenever you are not actively using them (Pouring, emptying, stirring). This is not optional. It is a rule in all labs at Yale and complies with federal and state regulations. This is to ensure that if you have to leave the area quickly in the even of an accident, fire alarm, phone call or other interruption that there won’t be unknown chemicals left in the bench. Label your glassware and find something to cover it with before you pour your chemicals so you don’t forget. Be sure that there is a proper waste bottle available before you pour your chemicals. If there is not, this may indicate that you are using chemicals that have not been approved in the cleanroom or a mixture that has not been approved so ask the staff before you proceed. If there is no waste bottle for your chemicals but you are sure it is an approved chemical or mixture, start a new waste bottle as described below in the Chemical Waste section.

Process Tanks:

The process tanks have seen very little use so far because they generate such large quantities of waste. Please see a staff member if you need to use the process tanks.

Empty bottles:

When you empty a bottle of fresh chemical it is your responsibility to dispose of the empty bottle. You must rinse the bottle with DI water at least 3 times. The rinsate should be poured down the drain. After rinsing you must deface the label of the bottle. If possible you should peel off the label. If not, cross it out with a permanent marker. Then you may place the bottle under the shelf between the Acid Hood and Solvent Hood to be reused as a waste bottle.

Chemical Waste

In the cleanroom we generate a significant amount of chemical waste. It is important to ensure that this waste is properly handled, labeled and stored to avoid injury and to comply with state and federal regulations.
Chemical Waste Storage

Chemical waste is stored in two places in the cleanroom. The first is at the point of use in the hoods. There is space for a limited number of bottles (6 or less) of frequently used waste in each hood. This is the safest and most convenient place for waste bottles that are in-use so that they don’t have to be transported very often. The hoods are exhausted and provide appropriate secondary containment for their respective waste chemicals. Each hood will have a list of waste bottles that may be stored on the bench top. Other waste streams that are generated less frequently will have to be stored on the bottom shelf of the appropriate cabinet/pass through. The corrosives cabinet has two trays on the bottom shelf that provide secondary containment for acid and caustic waste. Acids should be placed in the tray on the left side and caustics on the right side when looking at the cabinet from inside the CR. Users are responsible for transporting all full waste bottles from the hoods to the cabinets. As with fresh chemicals, this should be performed using the rubber bucket and heavy nitrile glove when acids or strong caustics are involved.

Starting a New Waste Bottle

Before starting a waste bottle, ensure that there is not already a waste bottle for your chemistry in the hood or in the cabinet. If you are sure there is no waste bottle, get the proper label from the file folder on the shelf. If no label is available, call the staff to print out more labels, or if no printed label is available use the OEHS label (red and white) and fill out completely. This may also be an indicator that the mixture you wish to generate is either incompatible or isn’t approved for use in the cleanroom. If you are unsure, ask the staff.

Never leave a waste bottle un-labeled
Never write directly on the bottle

Find a bottle that is compatible with your waste from beneath the wire shelf. Check to make sure that the bottle has been rinsed and affix the waste label to the new bottle. If you are using a chemical mixture containing hydrogen peroxide you must use a vented cap. A plastic bottle must be used for mixtures containing hydrofluoric acid (HF). If no appropriate waste bottle
is available, call the staff to get you one. *Do not start using chemicals until you know that a waste bottle is available.*

**Pouring out Waste**

When you are finished with your chemicals you must pour them into the proper waste container.

- Place the waste bottle next to the sink and put the funnel in the mouth of the container.
- Carefully pour the waste into the funnel making sure you don’t overfill the bottle.
- Once your container is empty, remove the funnel from the waste container making sure you don’t drip the residue from the funnel onto the bench-top or the outside of the bottle.
- Thoroughly rinse the funnel in the sink to remove chemical residue. If you dripped chemical on the outside of the bottle, put on the cap then put the bottle in the sink, rinse it off and dry it with a wiper.
- Clean any spills from the bench-top using water and a wiper.
- Rinse the contaminated wiper in the sink and squeeze out the water before disposing of it in the trash.
- Finally, rinse out your glassware thoroughly and set to one side.
- Rinse off the green gloves in the sink and blow or wipe them dry before removing them.
- Remove PPE
- If the waste bottle is not full and is one of the ones stored in the hood you may leave it in the back of the hood.
- If it is full, or it is not to be left in the hood, transport it to the cabinet using the rubber bucket and glove as described previously.
- Dry your glassware and return to storage.
2.5 Process Bench and Fume Hood Protocols

Tool 204A “Photoresist Spin/Bake Bench”

Chemicals allowed:

Clearly marked on bench sign posted on bench

Since we have limited work space and diverse user requirements, never store your solution on the bench tops, if you absolutely must keep a chemical solution greater than 24 hrs., find an appropriate container and clearly identify it, then store it in the chemical pass through.

If you need to reserve a section of bench top space for an experiment, log into Coral and reserve the bench for the duration of your experiment.

Resist dispense protocol:

- Resist / LOR will be dispensed using a disposable plastic pipette.
- The pipette will be used to draw a quantity of resist from a room-temperature “aliquot” bottle of resist, NOT from the quart or gallon “mother” bottle!
- Pipettes will not be reused – once the dispense and spin are completed, the pipette will be disposed of in a Ziploc baggie, which will then be placed in the cleanroom trash.
- The “aliquot” bottle will be refilled from the “mother” bottle ONLY after the mother bottle is allowed to come to room temperature, thus avoiding the introduction of water vapor from the room air. After being used to refill the aliquot, the mother bottle can be tightly recapped and returned to the refrigerator.

Spinner cleaning procedure:

- For AZ-type resists, the cleaning solvent of choice is Microchem EBR, **DO NOT SQUIRT ACETONE INTO THE LAUREL SPINNERS**, internal components are not compatible with acetone and will damage the spinner. For LOR resist, NMP seems to do a better job.
- Place a 3” dummy silicon wafer, properly centered, on the spinner chuck. Switch on the vacuum, and close the lid. Program the spinner to use a speed of 1000 rpm for two minutes (120 seconds). Start the spinner. While the wafer is spinning, use the squirt bottle to spray the solvent of choice onto the center of the wafer, through the hole in the lid of the spinner. Do this for about 15 seconds, then pause, then again for about 15 seconds. If the appearance of the spinner bowl
suggests that more cleaning is required, continue to spray for another 15 to 30 seconds. Now stop the spinner, open the lid, take out the dummy wafer, and use a lab wiper to wipe off all of the interior surfaces of the spinner. Dispose of the wipers in a manner similar to the plastic pipette – place them in a Ziploc baggie before disposing of them in the trash.

- Leave the spinner cleaner than you found it!

**Hot plate protocol:**

- Hot plates in this process bench are for **wafers and samples only** – no beakers, etc.
- Set the hot plate temperature(s) to the desired value(s) before spinning your sample.
- The 6” precision hot plate has a vacuum holddown feature to ensure intimate thermal contact with the sample, and is best used with whole wafers as opposed to small fragments. It is **essential** that the back of the wafer be clean and free of any resist residue! Use your tweezers and inspect the back of your sample before placing it on this hot plate. If it’s not clean, don’t bake it – strip it and recoat.
- Failure of the exhaust to the bench will disable the hot plates, as well as the resist spinners.

**Tool 103 “Resist Spin/Bake Bench”**

**Chemicals allowed:**

Clearly marked on bench sign posted on bench

**Resist dispense protocol:**

- Resist / LOR will be dispensed using a disposable plastic pipette.
- The pipette will be used to draw a quantity of resist from a room-temperature “aliquot” bottle of resist, NOT from the quart or gallon “mother” bottle!
- Pipettes will not be reused – once the dispense and spin are completed, the pipette will be disposed of in a Ziploc baggie, which will then be placed in the cleanroom trash.
- The “aliquot” bottle will be refilled from the “mother” bottle ONLY after the mother bottle is allowed to come to room temperature, thus avoiding the introduction of water vapor from the room air. After being used to refill the aliquot, the mother bottle can be tightly recapped and returned to the refrigerator.
Spinner cleaning procedure:

- For AZ-type resists, the cleaning solvent of choice is Microchem EBR, **DO NOT SQUIRT ACETONE INTO THE LAUREL SPINNERS**, internal components are not compatible with acetone and will damage the spinner. For LOR resist, NMP seems to do a better job.
- For most electron resists (PMMA/PMAA), acetone is probably the most effective.
- Place a 3” dummy silicon wafer, properly centered, on the spinner chuck. Switch on the vacuum, and close the lid. Program the spinner to use a speed of 1000 rpm for two minutes (120 seconds). Start the spinner. While the wafer is spinning, use the squirt bottle to spray the solvent of choice onto the center of the wafer, through the hole in the lid of the spinner. Do this for about 15 seconds, then pause, then again for about 15 seconds. If the appearance of the spinner bowl suggests that more cleaning is required, continue to spray for another 15 to 30 seconds. Now stop the spinner, open the lid, take out the dummy wafer, and use a lab wiper to wipe off all of the interior surfaces of the spinner. Dispose of the wipers in a manner similar to the plastic pipette – place them in a Ziploc baggie before disposing of them in the trash.

  - **Leave the spinner cleaner than you found it!**

Heated Ultrasonic process tank usage:

- Tank heater and ultrasonic generator are disabled until/unless the fluid level is high enough to raise the twin floats at the back of the tank.
- The tank is filled manually, and is drained into a built-in waste tank.
- The ultrasonic generator switch and the tank heater switch and temperature control are in the process bench head case. **DO NOT HEAT ANY FLUID ABOVE ITS FLASH POINT** in this tank. NMP = 95˚ C, acetone = -20˚ C, methanol = 12˚ C.
- The tank drain is disabled if the fluid temperature is above a setpoint, currently believed to be around 65˚ C.
- Failure of the exhaust to the bench will disable the tank heater and the ultrasonic generator.
- The process tank has a stainless cover. When the tank is not in use, the cover provides more worktop area.

Hot plate protocol:

- See description under tool 204A, above.
Failure of the exhaust to the bench will disable the hot plates, as well as the resist spinners, in this bench.

**Tool 103A “Soft Litho/MEMS Spin/Bake Bench”**

Chemicals allowed:

Clearly marked on bench sign posted on bench

Resist dispense protocol:

- SU-8 and PDMS are generally too viscous for the disposable pipettes. Other dispense methods will have to be employed.
- See comments below regarding the preparation of the spinner inside surfaces.

Spinner cleaning procedure:

- It is ESSENTIAL that the spinner be cleaned immediately after use, as the materials used in this tool are known to harden up in a short period of time, and will surely foul the spinner, necessitating downtime and potentially expensive repairs.
  - It is traditional to protect the inside of the spinner with filter paper, lab wipes, or aluminum foil prior to spinning. This has the disadvantage that it is messy to clean up and dispose of the trash. The advantage is that it does help prevent contact of the fluid with the spinner inner surfaces. Until/unless we come up with a better cleaning method, this might be the only viable option for this spinner. In any case, dispose of the spinner trash properly, in a plastic Ziploc bag, to reduce odor problems.
  - **Leave the spinner Cleaner than you found it!**

Heated Ultrasonic process tank usage:

- See description under Tool 103
- Failure of the exhaust to the bench will disable the tank heater and the ultrasonic generator.
Hot plate protocol:

- Hot plates in this process bench are for **wafers and samples only** – no beakers, etc.
- Set the hot plate temperature(s) to the desired value(s) before spinning your sample.
- Ensure the back of your sample is clean and devoid of spun material before baking. Failure to do so may result in (1) soiling of the top of the hot plate, and/or (2) destructive adhesion of your sample permanently to the hot plate.
- Failure of the exhaust to the bench will disable the hot plates, as well as the resist spinners.
Tool 106 “Solvent Hood”

Chemicals allowed:

Clearly marked on bench sign posted on bench

Heated ultrasonic tank usage:

- See description under Tool 103, above. Be advised, however: this hood has a second “phantom” tank opening in the worktop, but there is no tank beneath the cover – it’s just an opening to the plenum below.
- Failure of the exhaust to the bench will disable the tank heater as well as the ultrasonic generator.
- The process tank has a stainless cover. When the tank is not in use, the cover provides more worktop area.

Hot plate usage:

- *This hood is equipped with one explosion-proof hot plate, and one explosion-proof stirring hot plate.* These two hotplates are intended for heating beakers, not for baking wafers.
- “Explosion-proof” simply means the hot plate does not contain any ignition sources, like thermostat contacts. It does not mean that the fluid you are heating will not catch fire! Do not heat any fluid above its flash point temperature with these hot plates (or any other hot plates, for that matter). See the MSDS to verify flash points.
- These hot plates do not have temperature readouts. Use an immersion thermometer to monitor the temperature of the fluid you are heating. Do not “walk away” from a beaker of fluid being heated on a hot plate in this hood!
- Failure of the exhaust to the bench will disable the hot plates.

Tool 104 “Acid Hood”

Chemicals allowed:

- Mineral Acids (sulfuric, hydrochloric, nitric, phosphoric)
- Acetic Acid and mixtures
- HF, BHF
- DI water
- Bromine
- Other acid mixtures (etches, etc)
Hot plate usage:

- This hood is equipped with one ceramic-top hot plate, and one ceramic-top stirring hot plate. These two hotplates are intended for heating beakers, not for baking wafers.
- Failure of the exhaust to the bench will disable the hot plates.

Heated process tank protocol:

- The tank heater is disabled if the level of fluid in the tank is below approx. 60% full.
- The heater controls are located on the headcase: a switch for enabling the tank heater, and a temperature controller for setting the desired tank temperature.
- Samples may be placed in the process tank using single-wafer dipsticks, or cassettes, or other suitable holders. Simply placing a wafer or other sample in the tank without some sort of holder is probably a bad idea – “fishing” the sample out of the tank after it has been processed will be problematic at best, and most likely hazardous.
- The protocol for emptying the tank, and the built-in waste tank, is similar to that described for Tool 103, above. Interlocks are provided to prevent emptying a tank before it has been allowed to cool. It is still vitally important that the waste tank be emptied, and the process tank rinsed down with DI, prior to leaving the hood!
- This tank and the unheated process tank (see below) share the same waste tank. Do not empty the process tank unless you know the waste tank to be empty, to avoid unwanted chemical reactions in the waste tank.
- Do not use the heated process tank with HF-containing mixtures.
- Failure of the exhaust to the bench will disable the tank heater.
- The heated process tank has a plastic cover. When the tank is not in use, the cover provides more worktop area.

DI overflow rinse tank protocol:

- Samples may be placed in the overflow tank using single-wafer dipsticks, or cassettes, or other suitable holders, for final DI rinsing. Simply placing a wafer or other sample in the overflow tank without some sort of holder is probably a bad idea – “fishing” the sample out of the tank after it has rinsed will be problematic.
- The controls for the overflow tank are located in the headcase – a switch to start or stop the flow of DI into the tank, and a timer which will automatically stop the rinse process after the timer expires.
- The resistivity of the overflow tank effluent can be monitored with the resistivity meter in the headcase. The meter has a two-position
selector switch: one position monitors the incoming DI water to the hood; the other position monitors the tank effluent.

- The overflow tank drains to the plenum, and not to the internal waste tank, therefore no other fluids are allowed in the rinse tank – only DI water is allowed.
- The overflow rinse tank has a plastic cover. When the tank is not in use, the cover provides more worktop area.

**Tool 105 “Base Hood”**

**Chemicals allowed:**

- Ammonium hydroxide and mixtures
- Tetra-methyl ammonium hydroxide (TMAH) and mixtures
- Aqueous alkaline resist developers
- DI water
- Other aqueous alkaline mixtures and etches

**Hot plate usage:**

- See protocol listed above for Tool 104, Acid Hood.

**Heated process tank protocol:**

- See protocol listed above for Tool 104, Acid Hood, but substitute “alkaline” for “acid”.

**Unheated process tank protocol:**

- Same as for the heated tank, described above, with the following comment:
- Both the heated and the unheated tank will drain into the same built-in waste tank. It is important, when using both tanks, to drain and rinse out one of the tanks (thereby emptying and rinsing the waste tank) before emptying the other process tank.

**DI overflow rinse tank protocol:**

- See protocol listed above for Tool 104, Acid Hood
Tool 107 “CMOS Processing Hood”

Chemicals allowed:

Clearly marked on bench sign posted on bench

Hood usage restriction:

This hood is to be used only for CMOS-clean sample preparation and cleaning operations – no heavy metals, no metal-ion-bearing reagents. This tool in unique among the wet chemistry tools in the cleanroom, in that it has its own HEPA-filtered air supply above the worktop.

Hot plate usage:

- This hood is equipped with one ceramic-top hot plate, and one ceramic-top stirring hot plate. These two hotplates are intended for heating beakers, not for baking wafers. **These are not explosion proof, do not heat flammable solvents in this hood.**
- Failure of the exhaust to the bench will disable the hot plates.

Unheated process tank usage:

- Samples may be placed in the process tanks using single-wafer dipsticks, or cassettes, or other suitable holders. Simply placing a wafer or other sample in the tank without some sort of holder is probably a bad idea – “fishing” the sample out of the tank after it has been processed will be problematic at best, and most likely hazardous.
- The protocol for emptying the tanks, and the built-in waste tank, is similar to that described for Tool 103, above. It is still vitally important that the waste tank be emptied, and the process tank rinsed down with DI, prior to leaving the hood!
- The two process tanks have plastic covers. When the tanks are not in use, the cover provides more worktop area.

DI overflow rinse tank usage:

- See description above for Tool 104, Acid Hood
Welcome to OpenCoral. The OpenCoral Software System is a suite of software tools that is designed to help with the management and operation of advanced laboratories such as micro- and nano-fabrication facilities found in a number of universities.

What is OpenCoral?

For the user in the lab, it includes the following key capabilities:

- Allows equipment to be reserved in advance and to see who else has equipment reserved.
- Allows equipment to be enabled and disabled when in use to indicate to others that the equipment is in use.
- Report equipment problems and serious shutdown conditions.
- Quickly check on the operational status of each piece of equipment and examine more detailed reports of problem/shutdown conditions and their resolution.
- Allow checkout of laboratory supplies such as wafers, mask blanks, and storage containers.
- Optionally, collect and save run data during processing.

Starting a Remote Coral client at Yale

- Ensure you have a Coral account on the lab server. This should happen automatically once you are qualified to use the cleanroom.
- From a computer with a University IP number, point a browser to: http://uelmserver.eng.yale.edu/remotecoral
- Click on the "Remote OpenCoral" link. If you already have the Java runtime installed, it should eventually bring up a window that says "Coral Login Dialog". (On the way, it will ask you something about a "bouncy castle" and whether to trust it. The answer is "yes", even though this is an odd name.) If this login window does not come up, you might need to install the Java runtime environment (JRE). The other link on the web page
above, takes you to the Sun website for this purpose. You want Downloads -> Java SE -> JRE 6. Accept the license agreement, choose the download for your platform, download and install as an administrator.

- Your login name is your Yale NetID. Initially your remote Coral password is the same as your NetID. You may want to change this of course, but you can't change it unless you run a “local” Coral on a PC in the cleanroom, for security reasons. See a staff member to change your password.

- Once Coral opens, you will, on the left side of the window, see a hierarchy of objects with "Center for Microelectronic Materials and Structures" at the top, followed by “cleanroom”. The various categories and pieces of equipment are listed below “cleanroom”. To see the reservation, history, policy, and maintenance entries for a piece of equipment, select (click on) the item, then navigate with the tabs on the right side of the screen.

- Equipment currently in use will be listed with the NetID of the user after the equipment name, in parentheses. Equipment that you are qualified for will be listed with a star (*) to the right of the equipment name. You can make and delete reservations for such equipment, subject to that equipment’s reservation policies: after selecting the equipment, click on “Reservation Actions -> Make”. To delete a reservation, click on your reservation in the reservation time-and-date table, then click on “Reservation Actions -> Delete”.

- To use a piece of equipment, it must first be enabled on Coral. To enable, select the equipment as described above, then click on “Equipment Actions -> Enable”. Once you have finished with the item, it must be disabled using “Equipment Actions -> Disable”.

- To make a comment about, or report a problem with, a piece of equipment, click on the equipment name, and then click on “Equipment Actions -> Report Problem” or “Make Comment”. Equipment with one or more unresolved problems reported appears in the hierarchy with a yellow “traffic light” beside it. Equipment in shutdown status will appear with a red traffic light, and equipment in that status cannot be enabled. Equipment comments do not affect the status of the traffic light. Users are encouraged to make use of the comment and problem reporting facilities in Coral, as they provide useful information for the timely maintenance and repair of our equipment.
Other notes

- You can start a Remote Coral from any browser on the Internet by first connecting through the Yale VPN - this makes you appear to be on campus from the point of view of the server. See http://www.yale.edu/its/network/vpn.html for details.
- Your Coral account is for your use only, do not share your account with anyone else.
2.7 Miscellaneous

Cleanroom Cordless Phone/Intercom System

This system consists of a base unit and handset and 6 additional handsets throughout the cleanroom complex. These are 5.8 GHz phones, so range and interference should not be an issue in the vicinity of the cleanroom.

Base unit phone number: 432-4307

<table>
<thead>
<tr>
<th>Handset #</th>
<th>Location</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>Base unit, metrology bay (front section of cleanroom)</td>
</tr>
<tr>
<td>2</td>
<td>Lithography bay</td>
</tr>
<tr>
<td>3</td>
<td>Plasma bay</td>
</tr>
<tr>
<td>4</td>
<td>Entry</td>
</tr>
<tr>
<td>5</td>
<td>Room 528 (equipment/gas room)</td>
</tr>
<tr>
<td>6</td>
<td>Jim Agresta’s office (529)</td>
</tr>
<tr>
<td>7</td>
<td>Mike and Chris’s office (527)</td>
</tr>
</tbody>
</table>

Intercom feature:

Press int’com button
Select handset you wish to contact
Press Talk (green phone icon) to answer

DirectLink feature- allows you to use two phones as a two way radio
Both handsets must be in DirectLink mode

Press menu soft key
Select OK, follow directions press enter
Phone now in DirectLink mode, to call another handset
Press DirectLink soft key
Select handset to communicate with
If other handset not in DirectLink mode, display will show Out of Range
To receive call press Answer soft key or Talk
Some stored numbers

A few numbers are stored in the collective system (please don’t add personal numbers, these phones will occasionally be purged)

With phone in typical standby mode (as it sits in the charger)
Press 4 way button to left (book icon)
Press down to scroll through the phonebook
The following procedures and polices have been developed with the consideration and the cooperation of the Dean of School of Engineering and Applied Science, SEAS clean room staff, SEAS clean room faculty advisory committee, the Office of Environmental Health and Safety and the Provost’s Office. Every effort has been made to accommodate the needs of the research community while ensuring for prudent and necessary budget controls, as well as, the maintenance of a strong culture of safety.

The SEAS clean room management is fully empowered to implement and enforce policy including disciplinary protocol.

As with the Clean Room Handbook, this is a living document and will evolve over time with our experiences. Questions or comments regarding the content of this document should be submitted through the clean room staff at regularly scheduled user meetings. Changes to this documents will be posted on the clean room web site and distributed to the user community.
5.0 SEAS Cleanroom Policies

5.1. User Fees and Costs

Every effort has been made to develop a chargeback policy that is fair and consistent and adheres to all generally accepted accounting principals.

User fees will be reviewed by the Yale Provost's Office and cleanroom Director once per fiscal year or more frequently as warranted. Recommended fee adjustments are initiated by the Provost's Office and forwarded to the cleanroom Director for review and approval.

5.2. Time Keeping

All clean room users are required to swipe their proximity card at the main entrance reader upon entering and also upon exiting the facility this applies regardless if the door is previously open for someone else.

Although there are ways to defeat the time keeping system, clean room management and the Dean of Engineering fully expect honest and professional behavior to prevail.

Random review of surveillance date will be conducted to validate compliance. *Failure to comply with this protocol will result in the incident being treated as a Level 2 non-safety violation or you may be charged a four hour penalty per incident.*

5.3. Visitors/Guests

A visitor or guest is defined as anyone who is not a qualified cleanroom user, and has permission to enter the cleanroom with a host for the purposes of observation. If not a member of the Yale community, they must obtain a guest ID from a cleanroom staff member.
A host is defined as a qualified cleanroom user. Anyone wishing to bring a guest into the cleanroom should first notify the cleanroom manager for permission.

The host is responsible for the conduct and safety of their visitor/guest while in the cleanroom.

The visitor/guest is required to swipe in and out of the cleanroom, even if using a guest pass, and sign into the logbook available in the entry.

A visitor/guest may not perform any operations or operate any equipment in the cleanroom.

5.4. External customers
External customers are non Yale researchers who have been approved by the FoE business office, to have met and acknowledged the requirements and agreed to the non academic rate structure of the clean room.

5.5. Precious Metals

Precious metals defined as gold and platinum (as of 6/08)

The cleanroom inventory does not include precious metals, purchase and storage of precious metals for deposition, or other process requirements, will be the responsibility of each research group.
5.6. **Clean Room After Hours Policy**

5.6.1. **Hours of Operation**

The clean room is open to unrestricted operations Monday thru Friday 8AM until 5PM, the clean room is closed to all users on the following university holidays: New Years day, Thanksgiving day, and Christmas day. Any other closures will be posted.

5.6.2. **After Hours**

After hours are defined as hours beyond 8:00am – 5:00pm Monday thru Friday. Anyone who needs to work in the clean room after hours is required to adhere to the following protocols, without exception. *Failure to comply with these protocols will result in a level 1 or 2 safety violation. (please see section on discipline for explanation)*

5.6.3. **Protocols for after hours work in the clean room**

A clean room user must accumulate 30 hours or more of clean room experience and gain the approval of a staff member before being cleared for after hours entry. This means a clean room user’s ID badge will only work during normal business hours until this requirement has been met.

A clean room user may use the clean room after hours for allowed operations under the condition that they are accompanied by another qualified clean room user or they provide for another person, or remote buddy, to be responsible for checking up on them at least once per hour.
A buddy is defined as a trained and qualified cleanroom user, they must also be on campus, and they accept the responsibility to check on the safety and status of their labmate.

Until an improved system is implemented, there will be a sign in log for after hours, the log will include the name of the clean room user, the name of the designated buddy, operations to be performed, time in and time out.

Random audits of after hours logs and surveillance will be conducted to validate safety compliance.

5.6.4. Allowed Operations

The following tools and processes have been approved for unrestricted after hours use, in conjunction with above protocols.

- Lithography tools: vacuum bake/vapor prime, resist spin/bake, mask alignment/exposure, development, microscope inspection
- Operate vacuum deposition systems
- Operate metrology tools: Alpha Step, Ellipsometer, Nanometrics, microscopes
- TRE and Heidelberg mask makers
- MCS plasma asher
- Oxford 80 fluorine RIE/ICP
- GSI PECVD
- Solaris RTA
- CVD furnace
- Lindberg furnace

5.6.5. Restricted Operations

The following operations require another qualified user is present in the clean room because of the potential for an emergency situation requiring immediate assistance. *Since charges are accrued for any clean room*
**user entering the facility, it is strongly suggested to co-ordinate with someone with a mutual schedule from the same research group.**

**The following tools are currently available only during normal operating hours:**

- HF Vapor Etcher
- Oxford 100 chlorine RIE
5.7 **Discipline**

The clean room has enjoyed an excellent record of safety over the past 20 years, a tribute to the level of professionalism we have at Yale. On the rare occasions we must take disciplinary action, it is imperative we follow a procedure that ensures fairness and a quick resolution.

Every CR user is responsible for ensuring that laboratory safety procedures and protocols are followed. All users and staff members have the authority and responsibility to take immediate action to mitigate a safety or policy violation and to report it to the manager in charge.
Safety and Chemical Handling Violations

5.7.1 Levels of safety and chemical handling violations and immediate staff actions

**Level 1.** User knowingly disregards safety and/or procedures, resulting in injury to self or another.

**Staff action:** Immediately revoke clean room privileges, deactivate access indefinitely, convene safety review board

**Level 2.** User unknowingly disregards safety and/or procedures, resulting in injury to self or another.

**Staff action:** Immediately revoke clean room privileges, deactivate access for 3 month minimum, convene safety review board

**Level 3.** User knowingly disregards safety and/or procedures, not resulting in injury to self or another.

**Staff action:** Immediately revoke clean room privileges. Deactivate access for at least 4 weeks, generate record of discussion (RoD) within 10 days, take corrective actions, restrict future access.

**Level 4.** User unknowingly disregards safety and/or procedures, not resulting in injury to self or another.

**Staff action:** Immediately revoke clean room privileges. Deactivate access for at least 3 weeks, generate record of discussion (RoD) within 10 days, take corrective actions, restrict future access
5.7.2 Response to Violations resulting in injury (Levels 1 and 2)

Safety Review Board

A safety review board is reserved for laboratory incidents resulting in injury. It will convene within 10 days of the incident and will be responsible for collecting and documenting evidence and accounts of the incident. The board has the discretion to call any and all parties involved to clarify actions and behavior leading to the incident. Board members will convene in private to decide on corrective actions and the accused user will receive a decision in writing. The board will also generate an incident report along with any notices or policy changes needed to prevent future accidents. Incident reports are intended as educational tools, thus, names will be omitted prior to filing for public display.

The safety review board will be made up of a panel of the following people:

- CR director
- faculty advisor
- CR staff member
- OEHS representative

Record of discussion

The RoD report will contain, a brief description of the violation, the actual or potential outcome due to the violation, an account of any interviews, likely reasons for violation, corrective actions, signatures of involved parties. Multiple RoD’s will result in stiffer penalties for subsequent offenses.
5.7.3 Response to Violations not resulting in injury (Levels 3 and 4)

The CR manager-in-charge is responsible for taking immediate action and will begin investigating the incident. An investigation proceeds as follows:

- Interview person accused of violation
- Interview witnesses
- Consider immediate action
- Review with violator’s faculty advisor
- Issue a record of discussion (RoD) report within 10 working days
- Meet with violator to report final disposition
- RoD is signed by violator, CR manager, faculty advisor
- CR manager to hold original RoD
Protocol and equipment Operations
Violations

5.7.4 Levels of violations of protocols and equipment operations and immediate staff actions

**Level 1.** User knowingly disregards training and/or procedures, resulting in policy violation, damage or contamination to equipment or facility

**Staff action:** Immediate indefinite disqualification from cleanroom, assess damage, convene non-safety review board

**Level 2.** User unknowingly disregards training and/or procedures, resulting in policy violation, damage or contamination to equipment or facility,

**Staff action:** Immediate 4 week disqualification from cleanroom, assesses damage, convene non-safety review board, generate record of discussion (RoD) within 10 days, take corrective actions, limited and monitored access to equipment

**Level 3.** User knowingly disregards training and/or procedures, not resulting in damage or contamination to equipment or facility.

**Staff action:** Immediate 3 week disqualification from equipment, generate record of discussion (RoD) within 10 days, take corrective actions, limited and monitored access to equipment

**Level 4.** User unknowingly disregards training and/or procedures, not resulting in damage or contamination to equipment or facility.

**Staff action:** Immediate 2 week disqualification from equipment, generate record of discussion (RoD) within 10 days, take corrective actions, limited and monitored access to equipment
5.7.5 Response to violations of training and or protocols resulting in *policy violation*, damage or contamination of equipment or facility (Levels 1 and 2)

Non-Safety Review Board

A non-safety review board is reserved for laboratory incidents resulting in costly damage or contamination to facilities and or equipment. It will convene within 10 days of the incident and will be responsible for collecting and documenting evidence and accounts of the incident. The board has the discretion to call any and all parties involved to clarify actions and behavior leading to the incident. Board members will convene in private to decide on the appropriate cost liability and responsibility.

The non-safety review board will be made up of a panel of the following people

- CR director
- faculty advisor
- CR staff member
5.7.6 Response to violations in training and or protocols not resulting in damage or contamination of equipment or facility (Levels 3 and 4)

The CR manager-in-charge is responsible for taking immediate action and will begin investigating the incident. An investigation proceeds as follows:

- Interview person accused of violation
- Interview witnesses
- Consider immediate action
- Review with violator’s faculty advisor
- Issue a record of discussion (RoD) report within 10 working days
- Meet with violator to report final disposition
- RoD is signed by violator, CR manager, faculty advisor
- CR manager to hold original RoD

Record of discussion

The RoD report will contain, a brief description of the violation, the actual or potential outcome due to the violation, an account of any interviews, likely reasons for violation, corrective actions, signatures of involved parties. Multiple RoD’s will result in stiffer penalties for subsequent offenses.
5.8.0 Policy Changes

There will be times that warrant either a change or addition of policies which govern the cleanroom. In order to maintain fairness and careful consideration to safety and protocols:

- The proposal will be reviewed, it may need to be discussed with OEHS or Cleanroom committee.
- Any changes or differences will be discussed and or edited.
- Final version goes to CR Director for approval

5.8.1 Cleanroom Committee

This committee is a faculty review committee arranged from the 5 faculty members with the highest financial expenditure in the cleanroom. The Cleanroom Director has the option to nominate other faculty or PI's who may offer significant contributions. It also includes the deputy provost, FoE business manager, director for YINQUE, and the Cleanroom Director. It is the responsibility of the committee to

- review cleanroom capabilities and vulnerabilities present and near future
- review and discuss capital equipment additions
- review and discuss costs and charges
6.0 Safety

6.1.0 PPE

Eyewear
All occupants of the cleanroom are required to wear protective eyewear. Acceptable forms of eyewear include: safety glasses, chemical splash goggles, or prescription glasses with properly-fitting side shields. Glasses without side shields are not adequate. Also, contact lenses are not recommended when working with or around chemicals, due to the tendency of chemical vapors to collect behind the contact lens and irritate the cornea.

Gloves
All occupants of the cleanroom will don and wear a pair of gloves, for the protection of hands and fingers as well as the protection of cleanroom surfaces from fingerprints. Vinyl, latex, and nitrile gloves are acceptable for this purpose. Vinyl and nitrile gloves, as well as the heavier utility-grade gloves, are stocked in the cleanroom.

Apron
Chemically-resistant, aprons are available in the wet processing bay, and are to be worn when working with hot and/or strong acids, bases, or HF.

6.2.0 Material Safety Data Sheets (MSDS)
Two binders containing MSDS’s for all hazardous materials in the cleanroom will be kept in the gowning room. They are filed alphabetically with A-L in one binder and M-Z in the other.

The binders will be maintained by the cleanroom staff, with sections added when new chemicals or gases are approved and introduced into the cleanroom. Should you not find a datasheet that you think should be in the binders, please contact a staff member.
6.3.0 Toxic Gas Monitoring System

Status Panel
There are three status panels for the toxic gas monitoring system. One is in the cleanroom entryway, another is in the back of room 529, and the third is on the first floor of the Becton Center, near the Prospect St. entrance. The status panel normally displays the current detected quantity for 16 detection points in the cleanroom, and in the gas cabinets in room 528. If an alarm is raised, these panels can quickly provide information relating to the source of the alarm signal.

Indicator lights and horns
There are several sets of indicator lights for the toxic gas monitoring system. Each set is composed of three lights arranged horizontally: one white, one yellow/orange, and one red. The white light indicates a “low-level” alarm. The yellow/orange light indicates a “mid-level” alarm. The red light indicates a “high-level” alarm. When activated, the lights will “strobe” at a rate of about twice per second.

Actions to take in response to an alarm condition

Low-level “white light” alarm
- Contact Cleanroom staff
- If after hours, leave the cleanroom normally, notify staff or safety, do not re-enter until alarm is cleared.

Mid-level “yellow/orange light” alarm
- Leave cleanroom, assemble outside in hall (may degown and leave normally)
- Contact Cleanroom Tech staff as well as Yale ER Team (YPD, YFM, OEHS)
- Assemble and review events, plan for safe repair/response
- Do not re-enter cleanroom until alarms clear and staff members indicate it is safe to re-enter
High-level “red light” alarm

**LEAVE IMMEDIATELY**

- Building fire alarm will sound.
- Leave building, assemble outdoors *(leave cleanroom through nearest door, DO Not stop to degown)*
- Assemble outdoors or in another building and review events
- Do not re-enter building until alarms clear and fire department indicates it is safe to re-enter building
- Do not re-enter cleanroom until staff members indicate it is safe to re-enter.

The cleanroom is equipped with two emergency gas cabinet shutoff buttons. Activation of these buttons will cause all gas flows from the gas cabinets in 528 to shut off. This includes all of the toxic gases, flammable/pyrophoric gases, and oxidizing gases. As an aside, the gas cabinets will also shut off their output flow if the building fire alarm is activated. The gas cabinets will require a manual reset in order to reestablish the gas flow.

6.4.0 Chemical spills

All qualified cleanroom users have been trained in chemical spill response as part of the required on-line chemical safety training. Refer to Section 2.5 of the Yale University Chemical Hygiene Plan for spill cleanup information.

For all spills, alert people in immediate area and restrict access to spill location.

Identify the materials involved, quantity, and specific location of the spill. Evaluate hazard(s) and address personal contamination/injury. Summon any additional emergency services needed.

Only attempt to clean up a chemical spill if you are comfortable and confident that it can be done safely — if in doubt, use one of the ringdown phones to call for help. If the spill has caused the evolution of noxious vapors, leave the area immediately and call for help (785-
3555 – OEHS emergency phone number). If possible, cover with absorbent material to reduce vapors before leaving the area.

Wear basic protective equipment appropriate to hazard to clean small spills – if respiratory protection is needed, the incident is NOT minor and OEHS should be contacted immediately.

To clean minor spills, spill kits and neutralizer for acids, bases, and HF are kept in the wet process bay. Use appropriate material to absorb or neutralize spilled material. Work from perimeter inwards. Collect residue, place in heavy plastic bag or other receptacle, affix waste label describing contents, and contact Environmental Services for waste pick-up.

Clean spill area with soap and water.

6.5.0 First Aid

The first aid kit is kept in the gowning room, along with the gowning supplies.

Minor cuts, scrapes, burns can be treated using the supplies in the first aid kit. Move the victim to the gowning room for treatment if possible and appropriate.

If there is ANY possibility that the injury is anything beyond minor, or if the victim exhibits ANY symptoms of shock, use the ringdown phone (red button, no dialing required) to call for medical assistance.

6.5.1 Chemical exposure

Personal exposure to wet chemicals, particularly caustics, requires immediate action. Eyewashes and safety showers are located in the wet chemistry areas, as well as in the hallway outside the cleanroom. The victim should use the shower or the eyewash for at least 15 minutes to mitigate and dilute the chemical. Those assisting the victim should use the ringdown phone to call for emergency assistance (use the red button, no dialing required).

6.5.2 Hydrofluoric Acid, HF, is highly hazardous and can cause severe burns and death if not treated quickly. All areas where HF is used or stored should
have 2.5% calcium gluconate ointment immediately available. In the event of an HF exposure,

- Immediately remove contaminated PPE and contaminated clothing
- Shower and or rinse for 5 minutes.
- Gently rub calcium gluconate ointment onto the affected area.
- Call 911 or tell someone to call for emergency chemical exposure.
- Continue applying until emergency medical responders arrive. If the gluconate gel is not available, continue rinsing the affected area for a minimum of 15 minutes.
- Be sure to inform medical responders that the emergency involves HF exposure.
- When reasonable, report accident to cleanroom director.

**ALL cleanroom injuries, no matter how minor, must be reported to a lab staff member for documentation and, if appropriate, remediation of the hazard that caused the injury.**

**6.6.0 Fire**

The two double doors from the cleanroom to the hallway are the emergency exits. A fire alarm pull box is located adjacent to each door. An alarm will sound when the door is opened from the inside, so don’t be surprised. **Do not worry about your cleanroom garment when exiting the cleanroom under an emergency condition – you can remove it after you are in a place of safety.**

Should it be needed, a fire blanket is located in a vertical cabinet next to chase 2. It can be used to help douse the flames on a person who has caught fire. To use, pull the blanket out of the cabinet, then roll the person up in the blanket to smother the flames.

There are two fire extinguishers next to the emergency exits (double doors that go into the hallway). All cleanroom users are required to take the on-line Yale Fire Marshal’s Fire Extinguisher Training. Fire
extinguishers are located at several places in the cleanroom. They are of the “CO\textsubscript{2}” type. Before employing an extinguisher, pull a fire alarm box to summon assistance.

Operation of the extinguisher requires four steps:

1. pull the pin.
2. aim at base of flames
3. squeeze the trigger to release the CO\textsubscript{2} vapor
4. sweep the nozzle horizontally back and forth to smother the flames.

The memory key is “P A S S”:

Pull, Aim, Squeeze, Sweep.

*Only attempt to put out a fire if you have a clear escape path behind you, and you feel comfortable operating the extinguisher.*

In the event that the building fire alarm sounds, leave the cleanroom immediately (but in an orderly fashion: Don’t Panic) using the emergency exits to the hallway. Do not linger to shut down tools/processes. Do not worry about removing your cleanroom gown until you are in a place of safety. Do not reenter the building until the alarm has been turned off, and the Fire Department has indicated it is safe to reenter.

6.7.0 Ringdown phones

The cleanroom is equipped with three “ringdown boxes”: one in the wet process bay, adjacent to the sliding door; one adjacent to the CMOS process bench at the end of the metrology bay; and one at the end of the thermal bay. These boxes function similarly to the blue security boxes we see sprinkled around campus. Depending on how you actuate them, they can serve as a normal campus telephone, or to summon immediate emergency assistance from campus security and/or Yale Police.

To operate as a telephone,

Press the black button. you will hear a dial tone.
Now dial the phone number on the touchtone pad. The ringdown box now functions like a speakerphone for the remainder of your conversation.

To end the call, press the black button again.

In case of emergency, press the red button. No touch tone pad dialing is required. Yale Security (911) will answer the call, and the box will again function like a speakerphone.

**Be advised that Yale Security will know your location when they answer the call (they see “Becton Center, 5th floor, cleanroom”). Please be clear when stating your emergency to the dispatcher, who will then be able to summon the appropriate emergency responder. If Security does not get a response, a Yale Security Officer will be immediately dispatched to this location.**
7.0 Process Equipment

A: Chemical process benches

Manufacturer: ReynoldsTech, Syracuse NY
http://www.reynoldstech.com

Tool 204A “Photoresist Spin/Bake Bench”
Location: Litho Bay
Purpose: resist spinning and wafer baking
Material: Stainless Steel
Accessories:
Laurell spinner “Laurell1”
Headway spinner
SCS precision hotplate with vacuum holddown
(2) aluminum-top Barnstead hotplates
Underdeck explosion-proof refrigerator
Stand-alone utility timers
N2 spray gun
Exhaust interlock: Sounds audible alarm, and disables hot plates

Tool 103 “Resist Spin/Bake Bench”
Location: Wet process bay
Purpose: resist spin, wafer bake, wafer strip, etc.
Material: stainless steel
Accessories:
(2) Laurell spinners “Laurell2, Laurell3”
SCS precision hot plate with vacuum holddown
(2) aluminum-top Barnstead hot plates
In-deck heated, ultrasonic tank
In-deck drain sump with frontside manual drain
Utility sink with DI gooseneck faucet and point-of-use 0.2 μm filter
(2) DI deck hoses
(2) N2 spray guns
(4) Stand-alone utility timers
Exhaust interlock: Sounds audible alarm, and disables all accessory power
Safety interlocks for tank drain, tank level, ultrasonic generator, etc.
Tool 103A “MEMS / Soft Litho Spin/Bake Bench”
Location: Wet process bay
Purpose: resist spin, wafer bake, wafer strip, etc.
Material: stainless steel
Accessories:
- Laurell spinner “Laurell4”
- (2) aluminum-top Barnstead hot plates
- In-deck heated, ultrasonic tank
- In-deck drain sump with frontside manual drain
- Utility sink with DI gooseneck faucet and point-of-use 0.2 µm filter
- (2) DI deck hoses
- (2) N₂ spray guns
- (4) Stand-alone utility timers
Exhaust interlock: Sounds audible alarm, and disables all accessory power
Safety interlocks for tank drain, tank level, ultrasonic generator, etc.

Tool 106 “Solvent Hood”
Location: Wet process bay
Purpose: solvent processing
Material: stainless steel
Accessories:
- aluminum-top explosion-proof hot plate
- aluminum-top explosion-proof stirring hot plate
- In-deck heated, ultrasonic tank
- In-deck drain sump with frontside manual drain
- Utility sink with DI gooseneck faucet and point-of-use 0.2 filter
- (2) DI deck hoses
- (2) N₂ spray gun
- Stand-alone utility timers
- Yellow hood light
Exhaust interlock: Sounds audible alarm, and disables all accessory power
Safety interlocks for tank drain, tank level, ultrasonic generator, etc.
Tool 104 “Acid Hood”
Location: Wet process bay
Purpose: acid processing
Material: FM4910-rated CPVC
Accessories:
- Ceramic-top hot plate
- Ceramic-top stirring hot plate
- In-deck heated tank
- In-deck DI cascade overflow rinse tank with DI resistivity probe
- DI resistivity monitor display
- In-deck drain sump with frontside manual drain
- Utility sink with DI gooseneck faucet and point-of-use 0.2 filter
- (2) DI deck hoses
- (2) N₂ spray guns
- (4) Stand-alone utility timers
- Yellow hood light
- Exhaust interlock: Sounds audible alarm, and disables all accessory power
- Safety interlocks for tank drain, tank level, etc.

Tool 105 “Base Hood”
Location: Wet process bay
Purpose: caustic/alkaline processing
Material: FM4910-rated CPVC
Accessories:
- Ceramic-top hot plate
- Ceramic-top stirring hot plate
- In-deck heated tank
- In-deck DI cascade overflow rinse tank with DI resistivity probe
- DI resistivity monitor display
- In-deck drain sump with frontside manual drain
- Utility sink with DI gooseneck faucet and point-of-use 0.2 filter
- (2) DI deck hoses
- (2) N₂ spray guns
- (4) Stand-alone utility timers
- Yellow hood light
- Exhaust interlock: Sounds audible alarm, and disables all accessory power
- Safety interlocks for tank drain, tank level, etc.
Tool 107 “CMOS Hood”
Location: thermal/plasma bay
Purpose: MOS-clean processing
Material: FM4910-rated CPVC
Accessories:
- HEPA fan filter box over entire work space
- Ceramic-top hot plate
- Ceramic-top stirring hot plate
- Benchtop ultrasonic cleaner
- (2) In-deck non-heated process tanks
- In-deck DI cascade overflow rinse tank with DI resistivity probe
- DI resistivity monitor display
- In-deck drain sump with frontside manual drain
- Utility sink with DI gooseneck faucet and point-of-use 0.2 filter
- (2) DI deck hoses
- (2) N₂ spray guns
- Vacuum wand suitable for 8” wafers
- (4) Stand-alone utility timers
- White Hood lights
- Exhaust interlock: Sounds audible alarm, and disables all accessory power
- Storage cupboards below deck
- Safety interlocks for tank drain, tank level, etc.

B: Deposition

Name: Pete, Tool ID 01
Type: e-beam and/or thermal, turbo pumped
Manufacturer: Kurt Lesker [http://www.lesker.com]
Materials: metals: gold, chrome, nickel, titanium, palladium

Name: Denton, Tool ID 02
Type: e-beam/thermal, cryopumped
Manufacturer: Denton Vacuum [http://www.dentonvacuum.com]
Materials: metals: gold, chrome, nickel

Name: Varian, Tool ID 04
Type: thermal evaporator, turbopumped
Manufacturer: Varian [http://www.varianinc.com]
Materials: some metals and dielectrics
Name: Edwards, Tool ID 03  
Type: thermal evaporator, cryopumped  
Manufacturer: Edwards High Vacuum  
Materials: Aluminum (CMOS-clean restricted use)

Name: Lesker, Tool ID 05  
Type: UHV sputter and thermal dep, cryopumped  
Manufacturer: Kurt Lesker  
Materials: Niobium and other superconductor-specific materials

C. Plasma

Name: Oxford80, Tool ID 101  
Type: RIE/ICP Etcher “PlasmaLab 80Plus”  
Manufacturer: Oxford Instruments  
Etch Chemistries: Fluorine-based halocarbons, SF6, O2, restricted use

Name: Oxford100, Tool ID 212  
Type: RIE/ICP Etcher (Loadlocked) “PlasmaLab System 100”  
Manufacturer: Oxford Instruments  
Etch Chemistries: Chlorine-based and fluorine-based chemistries, restricted use

Name: Oxford 180  
Type: RIE/ICP etcher (loadlocked)  
Manufacturer: Oxford Instruments  
Etch Chemistries: Fluorine-based SF6, Bosch and cryo deep etch

Name: GSI, Tool ID 06  
Type: plasma-enhanced chemical vapor deposition (PECVD) system  
Manufacturer: GSI  
Materials: deposition of dielectrics - SiOx, SixNy

Name: MCS, Tool ID 07  
Type: Barrel / parallel-plate plasma asher/etcher  
Manufacturer: MCS  
Chemistries: oxygen, CF4: organic removal and dielectric etching
D. Thermal

Name: **CVD**, Tool ID 102  
Type: 4-stack diffusion furnace, 6" capable  
Manufacturer: CVD  
Chemistries: Wet/dry oxidation, forming-gas or inert anneal

Name: **RTA**, Tool ID 10  
Type: single-wafer rapid thermal processor (RTP), 6” capable “Solaris 150”  
Manufacturer: SSI  
Chemistries: Inert and reducing atmospheres
E. Lithography

Name: **EVG**, Tool ID 22  
Type: mask aligner, Model 620, 6” capable  
Manufacturer: EV Group, Inc.  [http://www.evgroup.com](http://www.evgroup.com)

Name: **Suss**, Tool ID 21  
Type: mask aligner, model MJB-3, 3” capable  

Name: **Heidelberg**, Tool ID 109B  
Type: laser writer, model DWL-66fs  
Manufacturer: Heidelberg Instruments  [http://www.himt.de](http://www.himt.de)

Name: **Laurell [1-4]**  
Type: Resist Spinners, model WS-400B-6NPP-LITE-IND  
Manufacturer: Laurell Technologies  [http://www.laurell.com](http://www.laurell.com)

Name: **Headway**  
Type: Resist spinner, 6” capable, model PWM32-PS-CB15  
Manufacturer: Headway Research  [http://www.headwayresearch.com](http://www.headwayresearch.com)

Name: **Yes1**, Tool ID 202A  
Type: Vacuum Pretreat oven with HMDS vapor, model 3TA  
Manufacturer: Yield Engineering Systems  [www.yieldengineering.com](http://www.yieldengineering.com)

Name: **Yes2**, Tool ID 202B  
Type: Vacuum image reversal oven with HMDS and NH₃ vapor, model 310TA  
Manufacturer: Yield Engineering Systems  [www.yieldengineering.com](http://www.yieldengineering.com)
F. Metrology

Name: Leitz, Tool ID 27
Type: inspection microscope
Manufacturer: Ernst Leitz GmbH http://www.leica-microsystems.com

Name: Zeiss, Tool ID 26
Type: Inspection Microscope

Name: Alphastep, Tool ID 24
Type: Alpha Step IQ surface profilometer
Manufacturer: KLA-Tencor http://www.tencor.com

Name: Rudolph, Tool ID 25
Type: Rudolph EL ellipsometer
Manufacturer: Rudolph Instruments http://www.rudolphinst.com

Name: Nanometrics, Tool ID 29
Type: spectroscopic reflectometer, NanoSpec AFT

G. Other

Name: CPD, Tool ID 11
Type: Liquid CO$_2$ critical-point dryer
Manufacturer: Toussimis, http://toussimis.com

Name: XeF2 etcher
Type: gas phase selective etching of Si
Manufacturer: Xactix, http://www.xactix.com

Name: HF Vapor phase etch tool
Type:
Manufacturer: